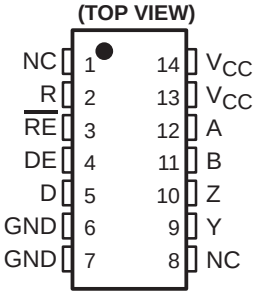
- **High-Speed Low-Power LinBICMOS™ Circuitry Designed for Signaling Rates† of up to 30 Mbps**
- **Bus-Pin ESD Protection Exceeds 12 kV HBM**
- **Very Low Disabled Supply-Current Requirements . . . 700 μA Maximum**
- **Designed for High-Speed Multipoint Data Transmission Over Long Cables**
- **Common-Mode Voltage Range of –7 V to 12 V**
- **Low Supply Current . . . 15 mA Max**
- **Compatible With ANSI Standard TIA/EIA-485-A and ISO 8482:1987(E)**
- **Positive and Negative Output Current Limiting**
- **Driver Thermal Shutdown Protection**

SN65LBC180AD (Marked as BL180A)
SN65LBC180AP (Marked as 65LBC180A)
SN75LBC180AD (Marked as LB180A)
SN75LBC180AP (Marked as 75LBC180A)
(TOP VIEW)



NC – No internal connection

description

The SN65LBC180A and SN75LBC180A differential driver and receiver pairs are monolithic integrated circuits designed for bidirectional data communication over long cables that take on the characteristics of transmission lines. They are balanced, or differential, voltage mode devices that are compatible with ANSI standard TIA/EIA-485-A and ISO 8482:1987(E). The A version offers improved switching performance over its predecessors without sacrificing significantly more power.

Function Tables

DRIVER

INPUT	ENABLE	OUTPUTS	
D	DE	Y	Z
H	H	H	L
L	H	L	H
X	L	Z	Z
Open	H	H	L

RECEIVER

DIFFERENTIAL INPUTS	ENABLE	OUTPUT
A – B	$\overline{RE}$	R
$V_{ID} \geq 0.2$ V	L	H
-0.2 V $< V_{ID} < 0.2$ V	L	?
$V_{ID} \leq -0.2$ V	L	L
X	H	Z
Open circuit	L	H

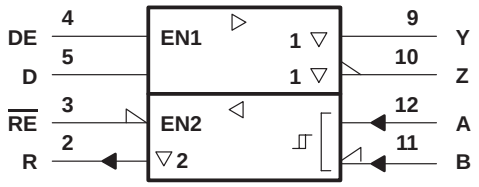
H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

These devices combine a differential line driver and differential input line receiver and operate from a single 5-V power supply. The driver differential outputs and the receiver differential inputs are connected to separate terminals for full-duplex operation and are designed to present minimum loading to the bus when powered off ($V_{CC} = 0$). These parts feature wide positive and negative common-mode voltage ranges, making them suitable for point-to-point or multipoint data bus applications. The devices also provide positive and negative current limiting for protection from line fault conditions. The SN65LBC180A is characterized for operation from –40°C to 85°C, and the SN75LBC180A is characterized for operation from 0°C to 70°C.

† Signaling rate by TIA/EIA-485-A definition restrict transition times to 30% of the bit length, and much higher signaling rates may be achieved without this requirement as displayed in the *TYPICAL CHARACTERISTICS* of this device.

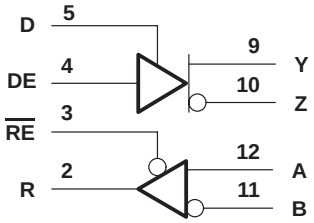
LinBiCMOS is a trademark of Texas Instruments.

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)

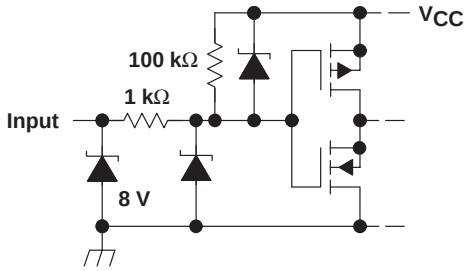


AVAILABLE OPTIONS

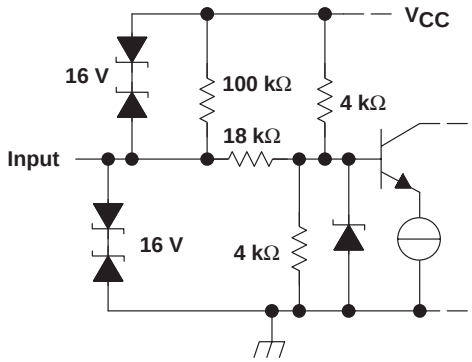
T_A	PACKAGE	
	SMALL OUTLINE (D)	PLASTIC DUAL-IN-LINE
0°C to 70°C	SN75LBC180AD	SN75LBC180AP
–40°C to 85°C	SN65LBC180AD	SN65LBC180AP

schematics of inputs and outputs

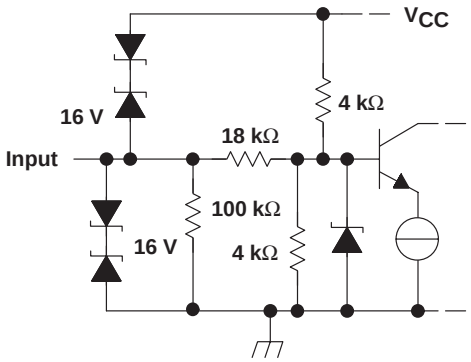
D, DE, and $\overline{RE}$ Inputs



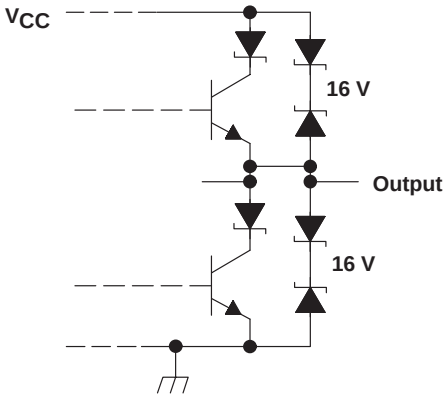
A Input



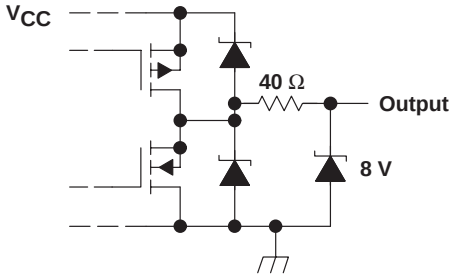
B Input



Y AND Z Outputs



R Output



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1) . . . . . –0.3 V to 6 V
Input voltage range, V_I (A, B)(see Note 1) . . . . . –10 V to 15 V
Voltage range at D, R, DE, $\overline{RE}$ (see Note 1) . . . . . –0.3 V to V_{CC} + 0.5 V
Continuous total power dissipation (see Note 2) . . . . . Internally limited
Total power dissipation . . . . . See Dissipation Rating Table
Electrostatic discharge: Bus terminals and GND, Class 3, A: (see Note 2) . . . . . 12 kV
Bus terminals and GND, Class 3, B: (see Note 2) . . . . . 400 V
All terminals, Class 3, A: . . . . . 4 kV
All terminals, Class 3, B: . . . . . 400 V
Storage temperature range, T_{stg} . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds . . . . . 260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND.
2. The maximum operating junction temperature is internally limited. Use the dissipation rating table to operate below this temperature.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR‡ ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 85°C$ POWER RATING
D	950 mW	7.6 mW/°C	608 mW	494 mW
N	1150 mW	9.2 mW/°C	736 mW	598 mW

‡ This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}		4.75	5	5.25	V
High-level input voltage, V_{IH}	D, DE, and $\overline{RE}$	2		V_{CC}	V
Low-level input voltage, V_{IL}	D, DE, and $\overline{RE}$	0		0.8	V
Differential input voltage, V_{ID} (see Note 3)		–12§		12	V
Voltage at any bus terminal (separately or common mode), V_O, V_I, or V_{IC}	A, B, Y, or Z	–7		12	V
High-level output current, I_{OH}	Y or Z	–60			mA
	R	–8			
Low-level output current, I_{OL}	Y or Z			60	mA
	R			8	
Operating free-air temperature, T_A	SN65LBC180A	–40		85	°C
	SN75LBC180A	0		70	

§ The algebraic convention where the least positive (more negative) limit is designated minimum, is used in this data sheet.

NOTE 3: Differential input/output bus voltage is measured at the noninverting terminal with respect to the inverting terminal.

driver electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IK}	Input clamp voltage	I_I = –18 mA		–1.5	–0.8		V
$\lvert V_{OD} \rvert$	Differential output voltage magnitude	R_L = 54 Ω,, See Figure 1	SN65LBC180A	1	1.5	3	V
			SN75LBC180A	1.1	1.5	3	
		R_L = 60 Ω,, See Figure 2	SN65LBC180A	1	1.5	3	
			SN75LBC180A	1.1	1.5	3	
$\Delta\lvert V_{OD} \rvert$	Change in magnitude of differential output voltage (see Note 4)	See Figures 1 and 2		–0.2		0.2	V
$V_{OC(SS)}$	Steady-state common-mode output voltage	See Figure 1		1.8	2.4	2.8	V
ΔV_{OC}	Change in steady-state common-mode output voltage (see Note 4)			–0.1		0.1	V
I_O	Output current with power off	V_{CC} = 0,	V_O = –7 V to 12 V	–10	±1	10	μA
I_{IH}	High-level input current	V_I = 2 V		–100			μA
I_{IL}	Low-level input current	V_I = 0.8 V		–100			μA
I_{OS}	Short-circuit output current	–7 V ≤ V_O ≤ 12 V		–250	±70	250	mA
I_{CC}	Supply current	V_I = 0 or V_{CC}, No load	Receiver disabled and driver enabled		5.5	9	mA
			Receiver disabled and driver disabled		0.5	1	
			Receiver enabled and driver enabled		8.5	15	

† All typical values are at V_{CC} = 5 V and T_A = 25°C.

NOTE 4: $\Delta\lvert V_{OD} \rvert$ and $\Delta\lvert V_{OC} \rvert$ are the changes in the steady-state magnitude of V_{OD} and V_{OC}, respectively, that occur when the input is changed from a high level to a low level.

driver switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	R_L = 54 Ω, C_L = 50 pF, See Figure 3	2	6	12	ns
t_{PHL}	Propagation delay time, high-to-low-level output		2	6	12	ns
$t_{sk(p)}$	Pulse skew ($\lvert t_{PLH} - t_{PHL} \rvert$)			0.3	1	ns
t_r	Differential output signal rise time		4	7.5	11	ns
t_f	Differential output signal fall time		4	7.5	11	ns
t_{PZH}	Propagation delay time, high-impedance-to-high-level output	R_L = 110 Ω, See Figure 4		12	22	ns
t_{PZL}	Propagation delay time, high-impedance-to-low-level output	R_L = 110 Ω, See Figure 5		12	22	ns
t_{PHZ}	Propagation delay time, high-level-to-high-impedance output	R_L = 110 Ω, See Figure 4		12	22	ns
t_{PLZ}	Propagation delay time, low-level-to-high-impedance output	R_L = 110 Ω, See Figure 5		12	22	ns

receiver electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IT+}	Positive-going input threshold voltage	I_O = –8 mA				0.2	V
V_{IT-}	Negative-going input threshold voltage	I_O = 8 mA		–0.2			V
V_{hys}	Hysteresis voltage ($V_{IT+} - V_{IT-}$)				50		mV
V_{IK}	Enable-input clamp voltage	I_I = –18 mA		–1.5	–0.8		V
V_{OH}	High-level output voltage	V_{ID} = 200 mV,	I_{OH} = –8 mA	4	4.9		V
V_{OL}	Low-level output voltage	V_{ID} = –200 mV,	I_{OL} = 8 mA		0.1	0.8	V
I_{OZ}	High-impedance-state output current	V_O = 0 V to V_{CC}		–1		1	µA
I_{IH}	High-level enable-input current	V_{IH} = 2.4 V		–100			µA
I_{IL}	Low-level enable-input current	V_{IL} = 0.4 V		–100			µA
I_I	Bus input current	V_I = 12 V, V_{CC} = 5 V	Other input at 0 V		0.4	1	mA
		V_I = 12 V, V_{CC} = 0 V			0.5	1	
		V_I = –7 V, V_{CC} = 5 V		–0.8	–0.4		
		V_I = –7 V, V_{CC} = 0 V		–0.8	–0.3		
I_{CC}	Supply current	V_I = 0 or V_{CC}, No load	Receiver enabled and driver disabled		4.5	7.5	mA
			Receiver disabled and driver disabled		0.5	1	
			Receiver enabled and driver enabled		8.5	15	

† All typical values are at V_{CC} = 5 V and T_A = 25°C.

receiver switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	V_{ID} = –1.5 V to 1.5 V,	See Figure 7	7	13	20	ns
t_{PHL}	Propagation delay time, high- to low-level output			7	13	20	ns
$t_{sk(p)}$	Pulse skew ($\lvert t_{PHL} - t_{PLH} \rvert$)				0.5	1.5	ns
t_r	Output signal rise time	See Figure 7			2.1	3.3	ns
t_f	Output signal fall time				2.1	3.3	ns
t_{PZH}	Output enable time to high level	C_L = 10 pF,	See Figure 8		30	45	ns
t_{PZL}	Output enable time to low level				30	45	ns
t_{PHZ}	Output disable time from high level				20	40	ns
t_{PLZ}	Output disable time from low level				20	40	ns

PARAMETER MEASUREMENT INFORMATION

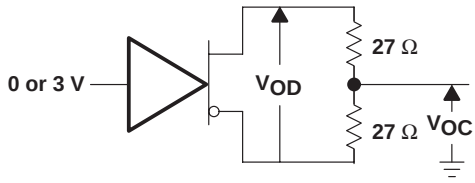


Figure 1. Driver V_{OD} and V_{OC}

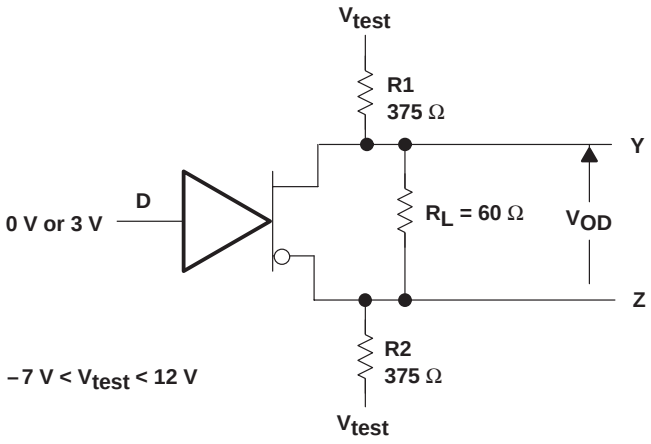
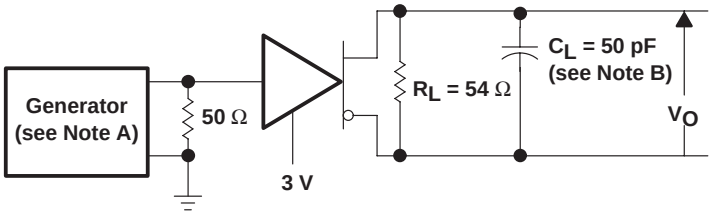
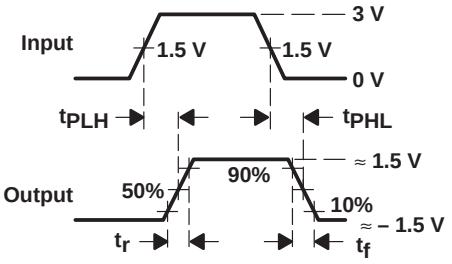


Figure 2. Driver V_{OD3}



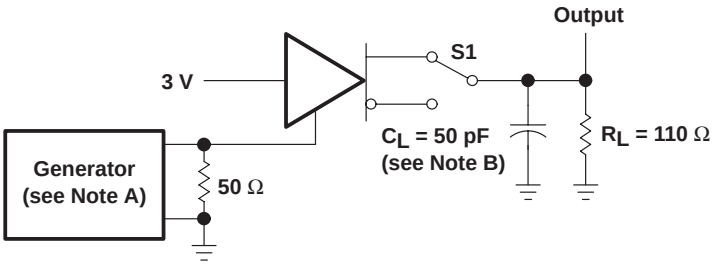
TEST CIRCUIT



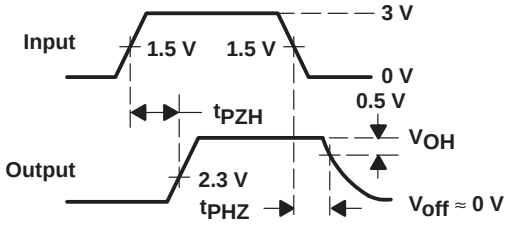
VOLTAGE WAVEFORMS

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6 ns, Z_O = 50 Ω.
B. C_L includes probe and jig capacitance.

Figure 3. Driver Test Circuit and Voltage Waveforms



TEST CIRCUIT

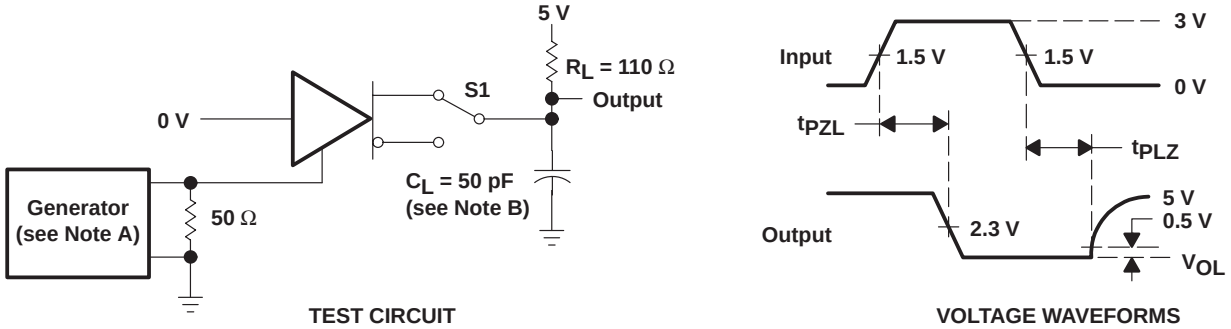


VOLTAGE WAVEFORMS

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6 ns, Z_O = 50 Ω.
B. C_L includes probe and jig capacitance.

Figure 4. Driver Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6 ns, Z_O = 50 Ω.
B. C_L includes probe and jig capacitance.

Figure 5. Driver Test Circuit and Voltage Waveforms

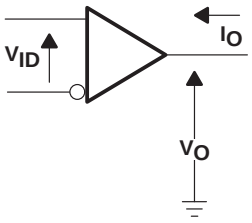
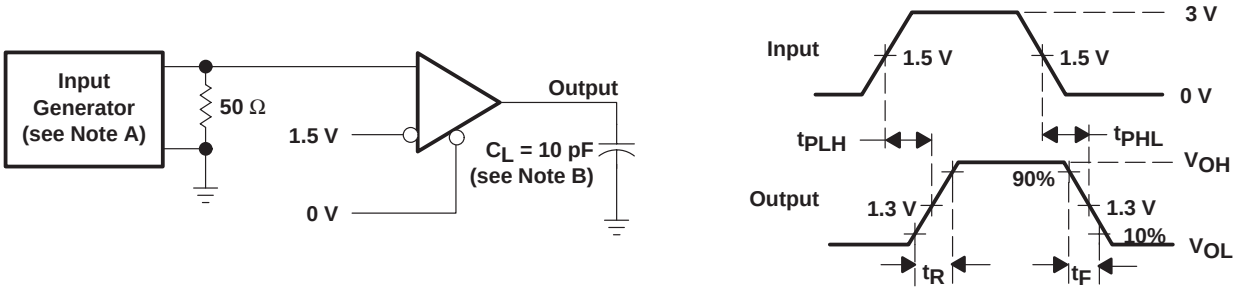


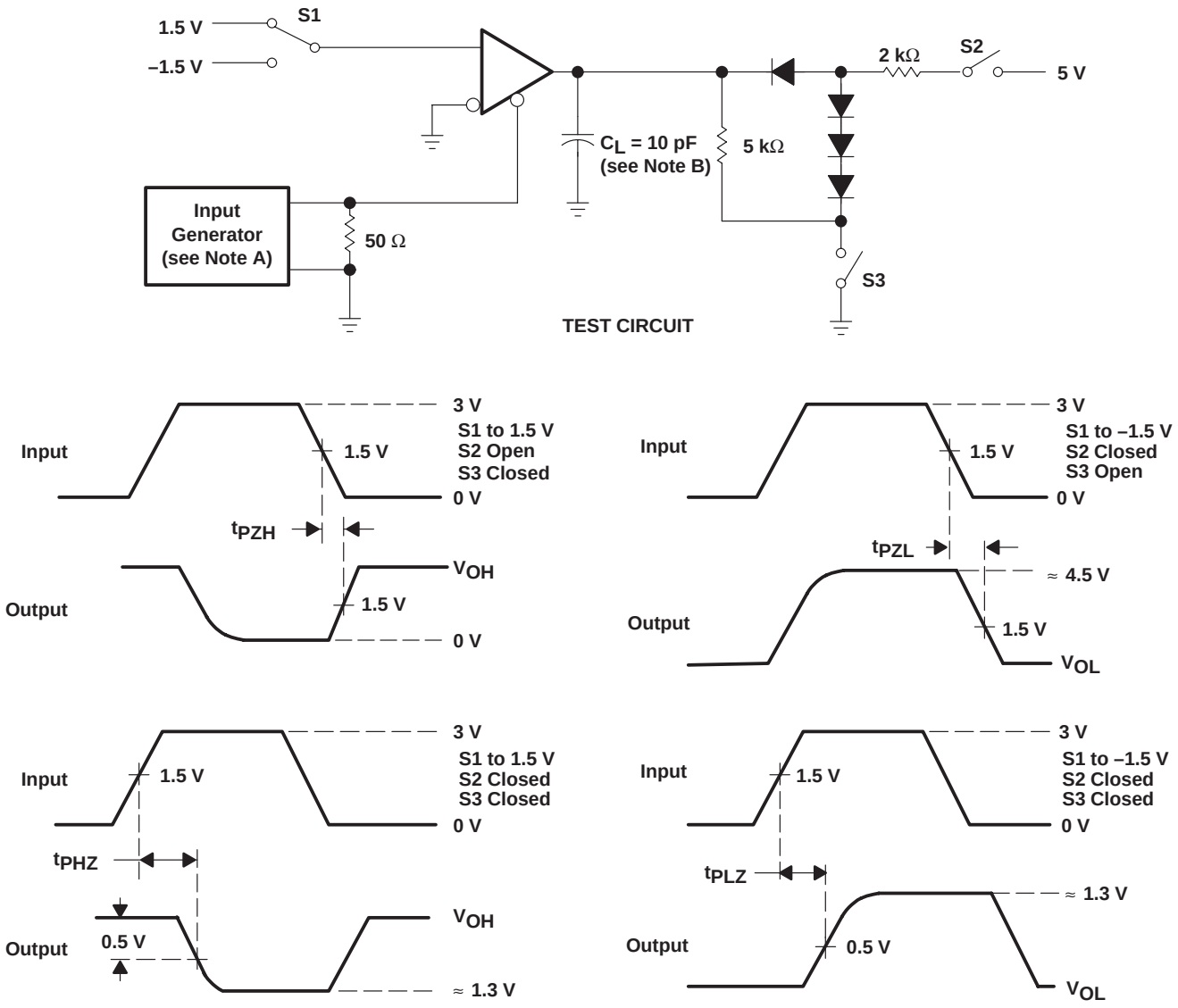
Figure 6. Receiver V_{OH} and V_{OL}



NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6 ns, Z_O = 50 Ω.
B. C_L includes probe and jig capacitance.

Figure 7. Receiver Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, 50% duty cycle, t_r ≤ 6 ns, t_f ≤ 6 ns, Z_O = 50 Ω.
B. C_L includes probe and jig capacitance.

Figure 8. Receiver Output Enable and Disable Times

TYPICAL CHARACTERISTICS

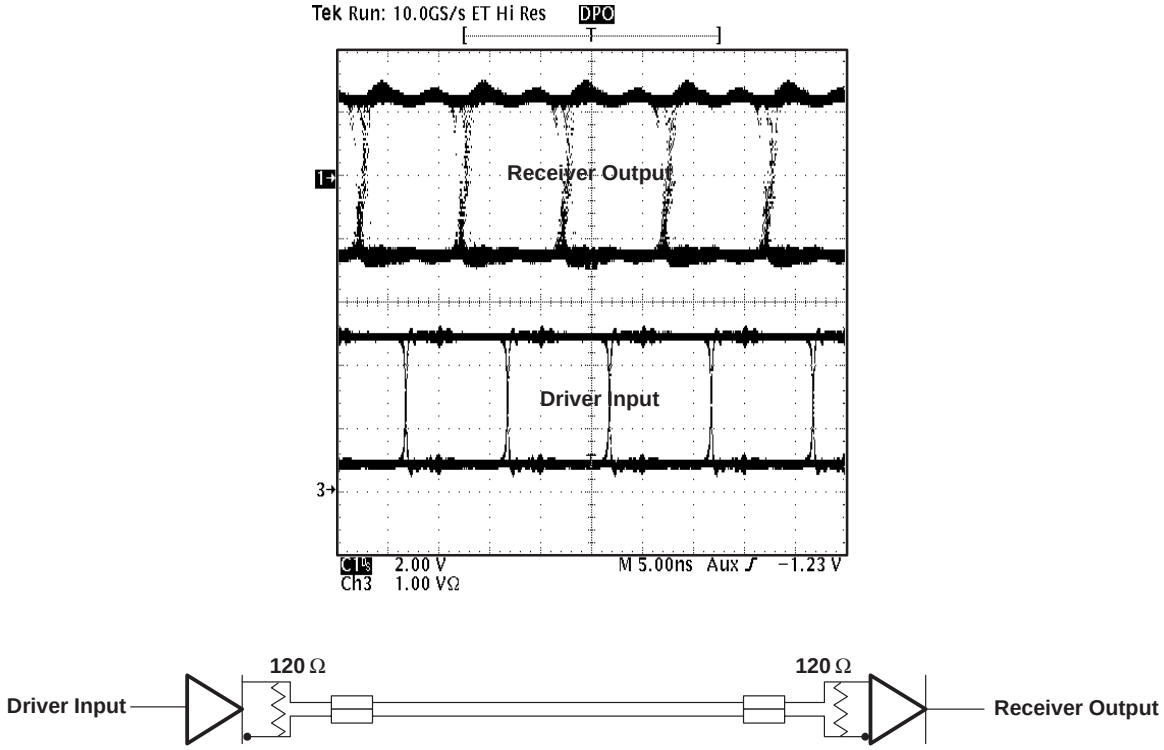


Figure 9. Typical Waveform of Non-Return-To-Zero (NRZ), Pseudorandom Binary Sequence (PRBS) Data at 100 Mbps Through 15m, of CAT 5 Unshielded Twisted Pair (UTP) Cable

TIA/EIA-485-A defines a maximum signaling rate as that in which the transition time of the voltage transition of a logic-state change remains less than or equal to 30% of the bit length. Transition times of greater length perform quite well even though they do not meet the standard by definition.

TYPICAL CHARACTERISTICS

AVERAGE SUPPLY CURRENT vs FREQUENCY

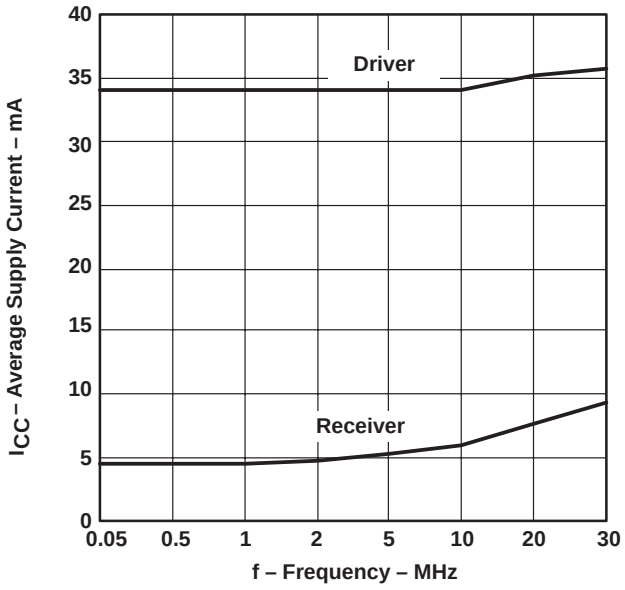


Figure 10

LOGIC INPUT CURRENT vs INPUT VOLTAGE

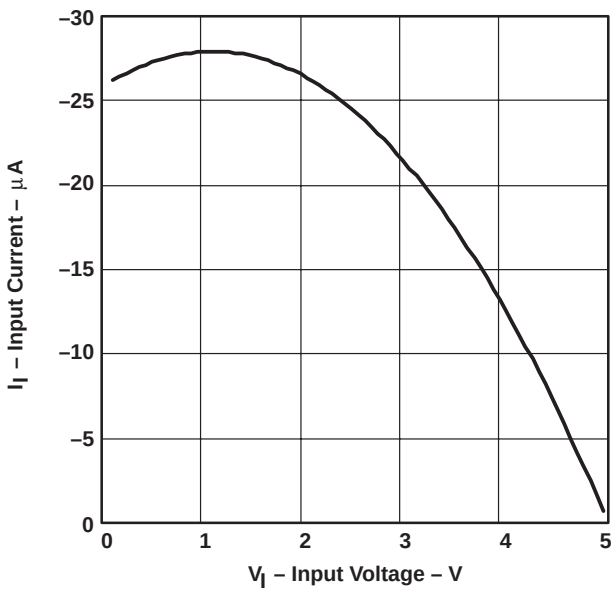


Figure 11

INPUT CURRENT vs INPUT VOLTAGE

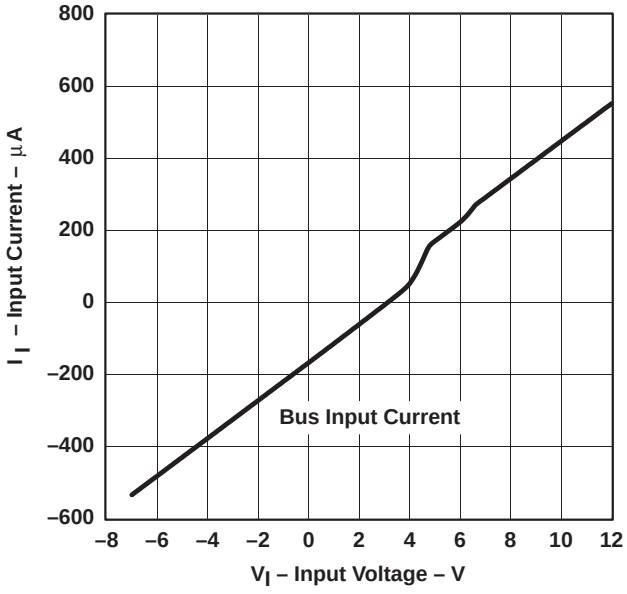


Figure 12

LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

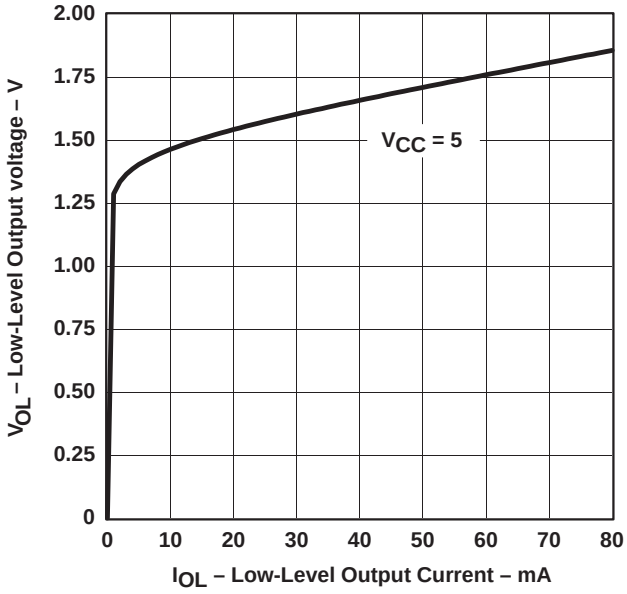


Figure 13

TYPICAL CHARACTERISTICS

DRIVER HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

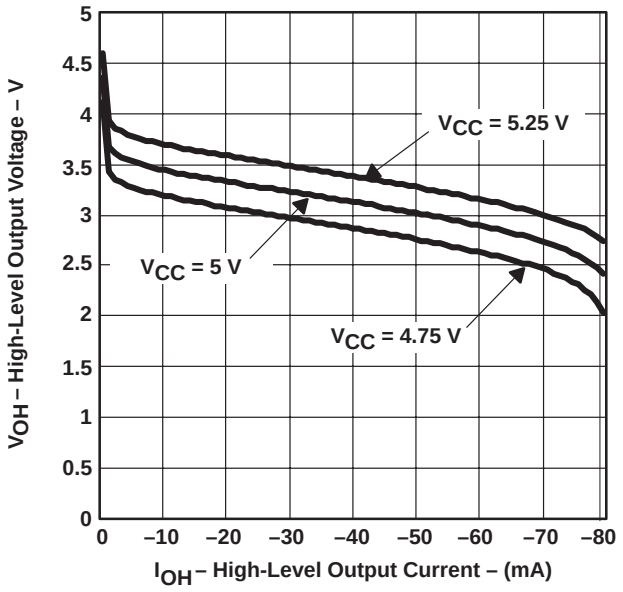


Figure 14

DRIVER DIFFERENTIAL OUTPUT VOLTAGE vs AVERAGE CASE TEMPERATURE

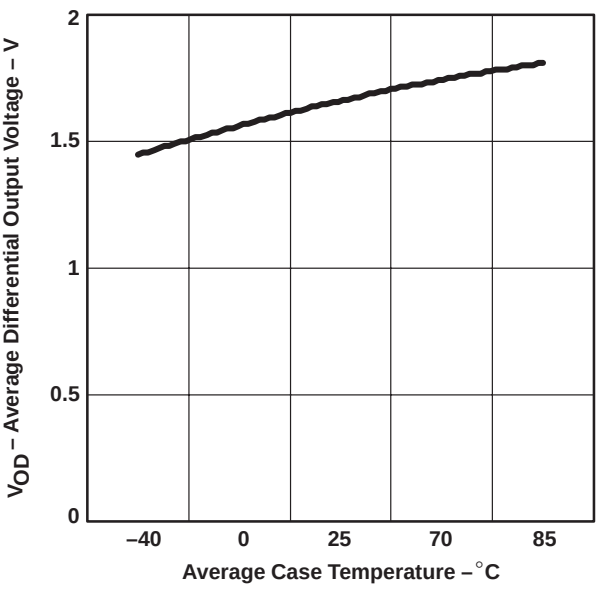


Figure 15

RECEIVER PROPAGATION TIME vs CASE TEMPERATURE

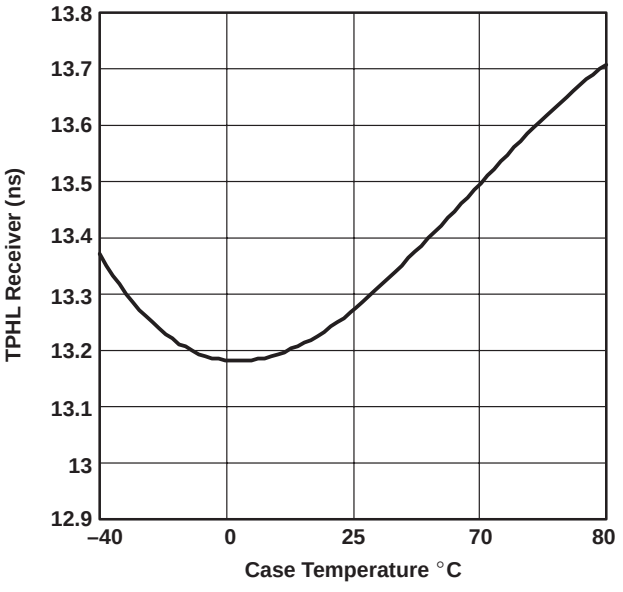


Figure 16

DRIVER PROPAGATION DELAY TIME vs CASE TEMPERATURE

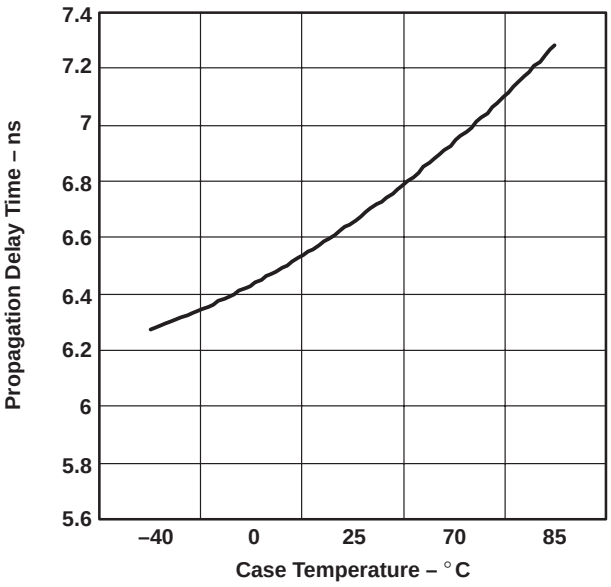


Figure 17

TYPICAL CHARACTERISTICS

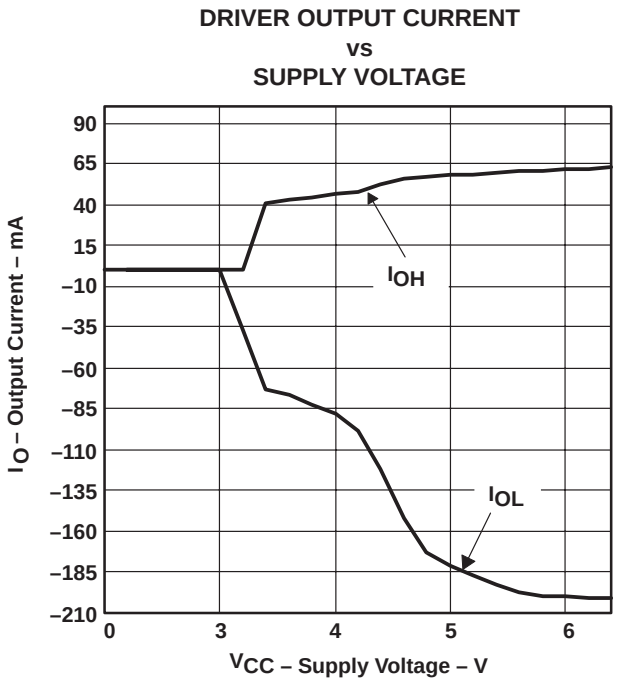
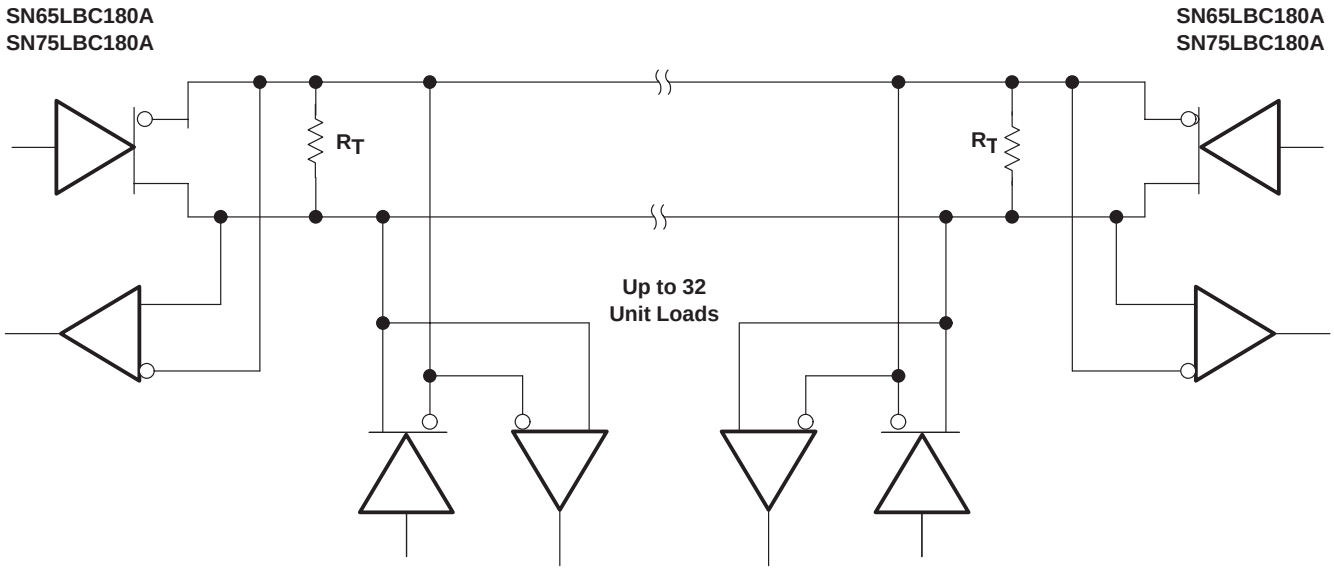


Figure 18

APPLICATION INFORMATION



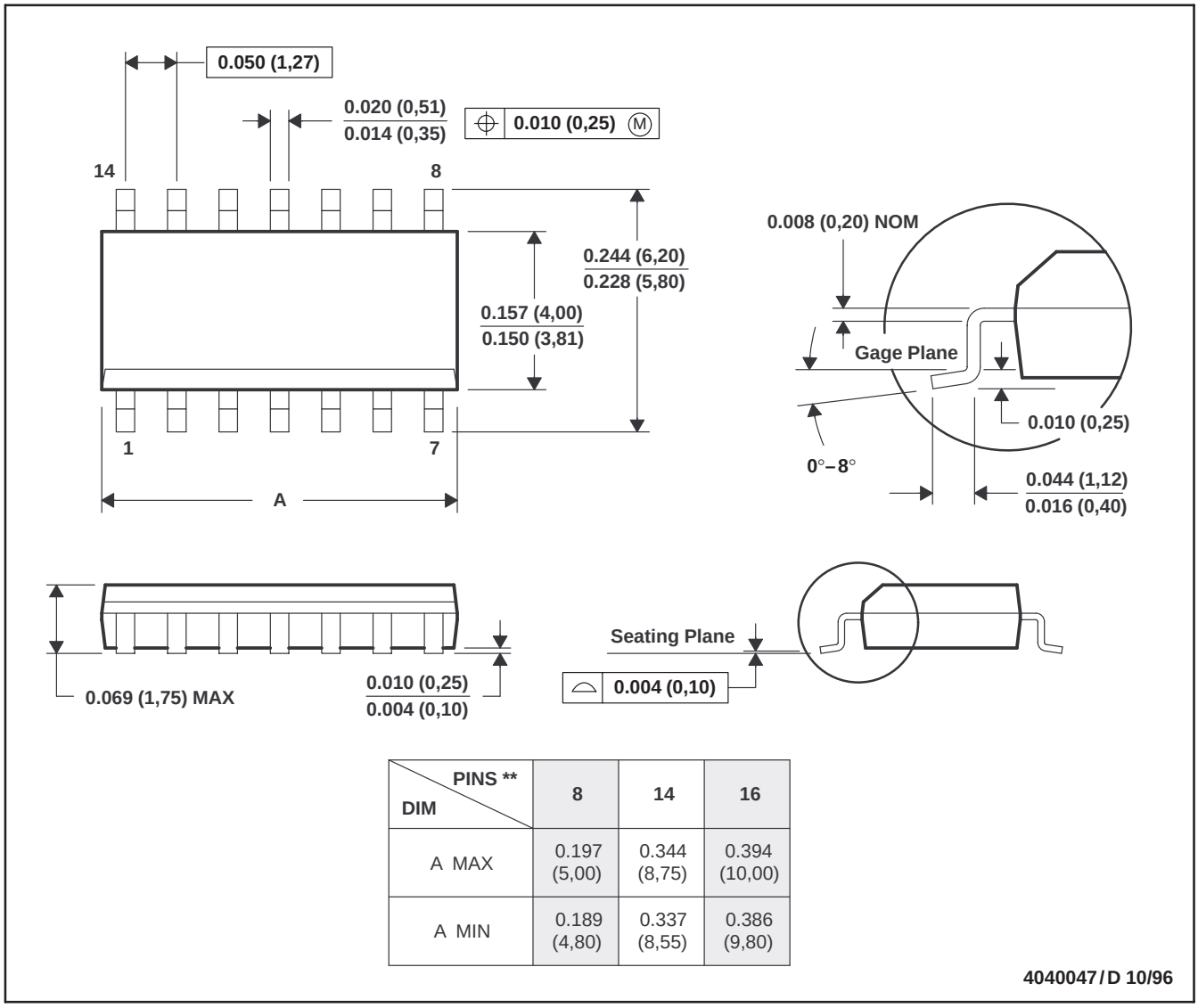
NOTE A: The line should be terminated at both ends in its characteristic impedance ($R_T = Z_O$). Stub lengths off the main line should be kept as short as possible. One SN65LBC180A typically represents less than one unit load.

Figure 19. Typical Application Circuit

MECHANICAL DATA

D (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



DIM \ PINS **	8	14	16
A MAX	0.197 (5,00)	0.344 (8,75)	0.394 (10,00)
A MIN	0.189 (4,80)	0.337 (8,55)	0.386 (9,80)

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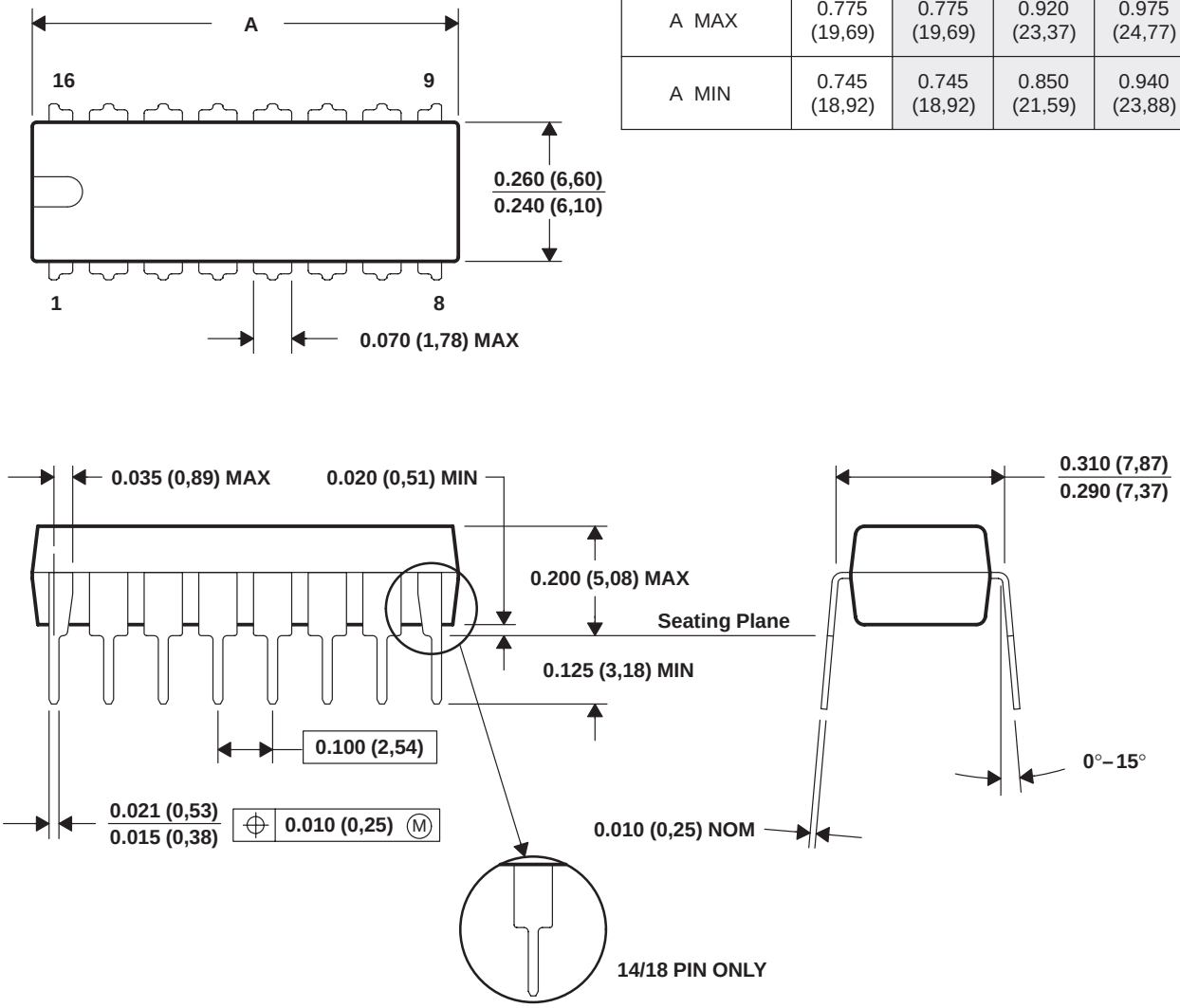
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
D. Falls within JEDEC MS-012

MECHANICAL DATA

N (R-PDIP-T)** **PLASTIC DUAL-IN-LINE PACKAGE**

16 PINS SHOWN

DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	0.975 (24,77)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-001 (20-pin package is shorter than MS-001).

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